

Product data sheet

1. General description

Ultrafast power diode in a 2-lead TO247-2L plastic package.

2. Features and benefits

- Fast switching
- Very low on-state loss
- Low leakage current
- Low thermal resistance

3. Applications

- Active PFC in air conditioner
- S.M.P.S Power Factor Correction (PFC)
- Half-bridge / full-bridge switched-mode power supplies

4. Quick reference data

Symbol	Parameter	Conditions	Values		Unit		
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			600			V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 129 °C; Fig. 1; Fig. 2; Fig. 3		30			A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 129 °C; square-wave pulse		60			А
I _{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; sine-wave pulse; <u>Fig. 4</u>	290			А	
		$t_{\rm p}$ = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse	330			А	
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 30 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.18	1.55	V
		I _F = 30 A; T _j = 150 °C; <u>Fig. 6</u>		-	0.98	-	V
Dynamic	characteristics						
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	42	75	ns
		$ I_{F} = 30 \text{ A}; V_{R} = 400 \text{ V}; dI_{F}/dt = 200 \text{A}/\mu\text{s}; \\ T_{j} = 25 ^{\circ}\text{C}; \underline{\text{Fig. } 7} $		-	65	-	ns
		I _F = 30 A; V _R = 400 V; dI _F /dt = 200 A/μs; T _i = 125 °C; <u>Fig. 7</u>		-	101	-	ns

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	А	anode		K — A 001aaa020
mb	mb	mounting base; connected to cathod	Г Г Г Г Г Г Г Г Г Г Г Г Г Г Г Г Г Г Г	

6. Ordering information

Table 3. Ordering information							
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
BYV30W-600PT2	TO247-2L	BYV30W-600PT2Q	Tube	30	TO247L-2L (L)	12-Nov-2020	
					TO247P-2L (P)	31-Mar-2023	

7. Marking

Table 4. Marking codes

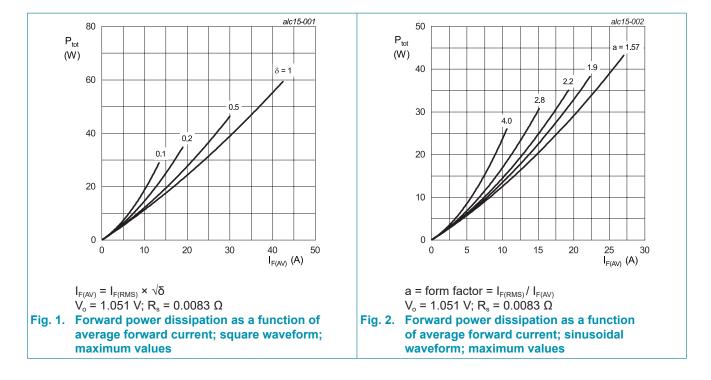
Type number	Marking codes		
	Assembly factory: L	Assembly factory: P	
BYV30W-600PT2	BYV30W 600PT2 PJLxxxx xx	BYV30W 600PT2 PJPxxxx xx	

8. Limiting values

Table 5. Limiting values

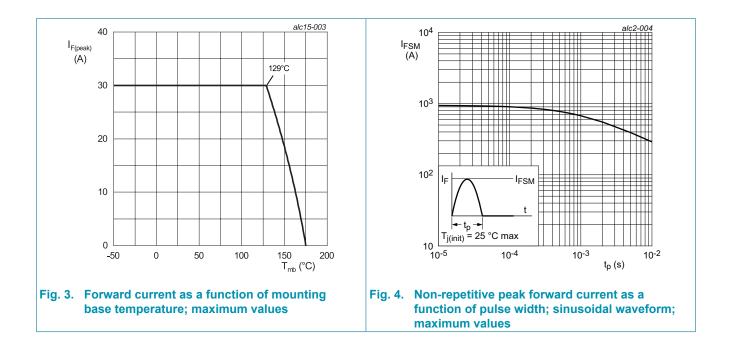
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V _{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	DC	600	V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 129 °C; Fig. 1; Fig. 2; Fig. 3	30	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 129 °C; square-wave pulse	60	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	290	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	330	A
T _{stg}	storage temperature		-55 to 175	°C
Tj	junction temperature		175	°C



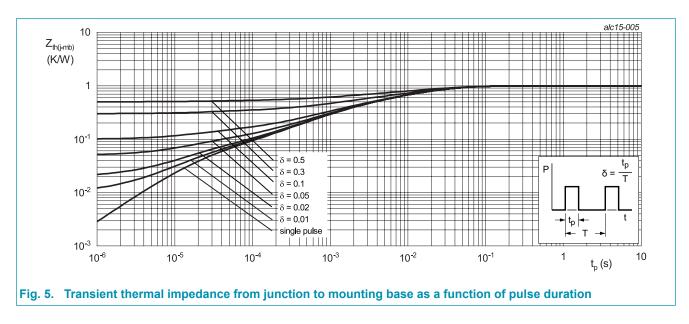
Ultrafast power diode

BYV30W-600PT2



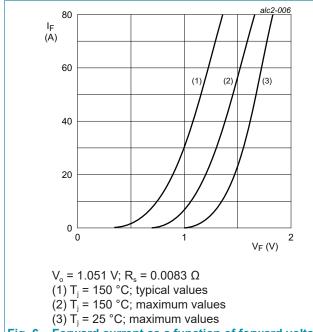
9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	-	1	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W



10. Characteristics

Table 7. C	haracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V _F	forward current	I _F = 30 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.18	1.55	V
		I _F = 30 A; T _j = 150 °C; <u>Fig. 6</u>	-	0.98	-	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	2	10	μA
		V _R = 600 V; T _j = 125 °C	-	-	500	μA
Dynamic	characteristics					
Qr	reverse charge	$ I_F = 30 \text{ A}; V_R = 400 \text{ V}; \text{d}_F/\text{d}t = 200 \text{ A}/\mu\text{s}; $ $ T_j = 25 ^\circ\text{C}; \underline{\text{Fig. } 7} $	-	272	-	nC
		$I_F = 30 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	775	-	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	42	75	ns
		$I_F = 30 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	65	-	ns
		I _F = 30 A; V _R = 400 V; dI _F /dt = 200 A/μs; T _j = 125 °C; <u>Fig. 7</u>	-	101	-	ns
I _{RM}	peak reverse recovery current	$I_F = 30 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	8.4	-	A
		$I_F = 30 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	15.2	-	A



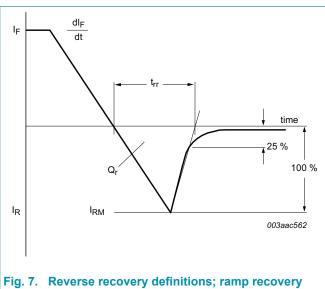
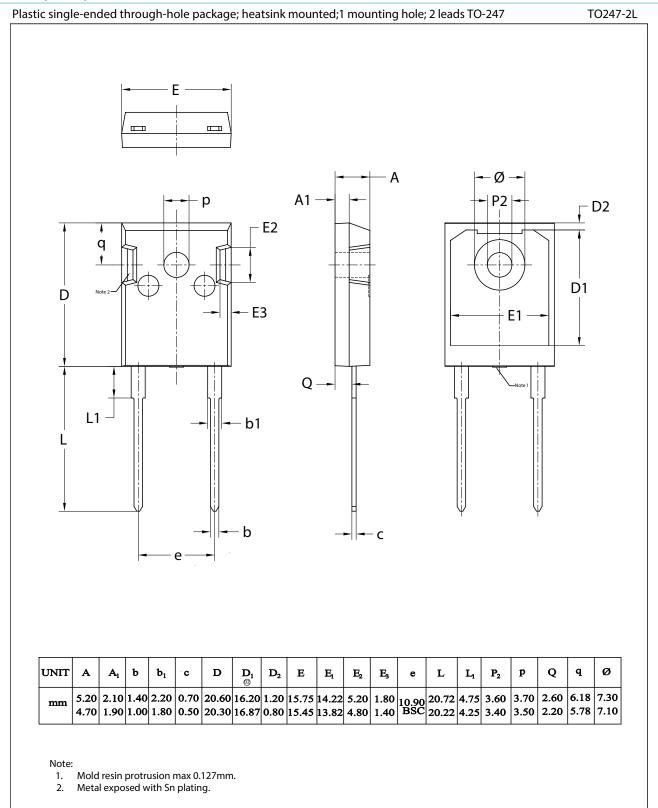


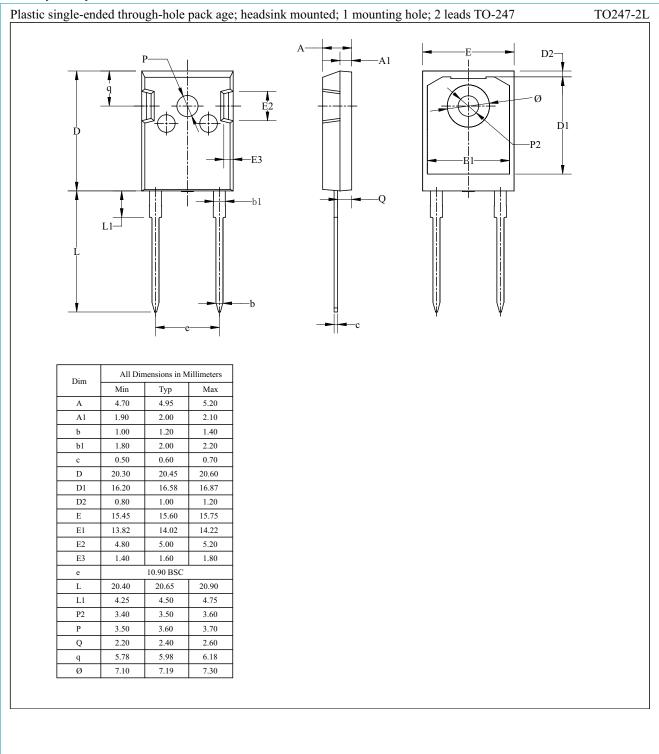
Fig. 6. Forward current as a function of forward voltage

11. Package outline

Assembly factory: L



Assembly factory: P



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Ultrafast power diode

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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